

16 A Three-quadrant triacs high commutation Rev. 01 — 11 April 2007

Product data sheet

1. **Product profile**

1.1 General description

Passivated, new generation, high commutation triacs in a SOT186A isolated full pack plastic package

1.2 Features

- Very high commutation performance maximized at each gate sensitivity
- High isolation voltage

1.3 Applications

- High power motor control e.g. washing Refrigeration and air conditioning machines and vacuum cleaners
- Non-linear rectifier-fed motor loads.

1.4 Quick reference data

- V_{DRM} \leq 600 V (BTA316X-600B/C/E)
- V_{DRM} ≤ 800 V (BTA316X-800B/C/E)
- I_{TSM} \leq 140 A (t = 20 ms)
- I_{T(RMS)} \leq 16 A

- High immunity to dV/dt
- Wide range of gate sensitivities
- compressors
- Electronic thermostats

2 SOT186A (TO-220F)

- I_{GT} \leq 50 mA (BTA316X series B)
- I_{GT} ≤ 35 mA (BTA316X series C)
- I_{GT} \leq 10 mA (BTA316X series E)

Pinning information 2.

| Pin | Description | Simplified outline | Symbol |
|-----|-------------------------|--------------------|--------|
| 1 | main terminal 1 (T1) | | |
| 2 | main terminal 2 (T2) | mb | T2-T1 |
| 3 | gate (G) | | Sym051 |
| mb | mounting base; isolated | | |
| | | | |
| | | ĨĨ | |



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3. Ordering information

| Type number | Package | | | | | | | | |
|--------------|---------|------------------------------------------------------------------------------------------------------------|---------|--|--|--|--|--|--|
| | Name | Description | Version | | | | | | |
| BTA316X-600B | TO-220F | 20F plastic single-ended package; isolated heatsink mounted; 1 mounting hole; 3-lead TO-220 'full pack' | | | | | | | |
| BTA316X-600C | | | | | | | | | |
| BTA316X-600E | | | | | | | | | |
| BTA316X-800B | | | | | | | | | |
| BTA316X-800C | | | | | | | | | |
| BTA316X-800E | | | | | | | | | |

4. Limiting values

Table 3. Limiting values

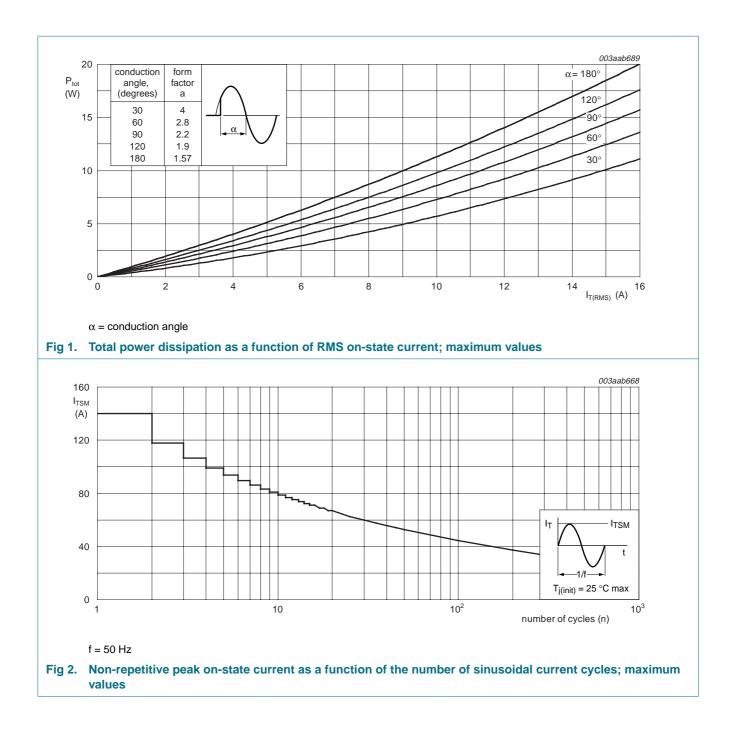
In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-------------------------------------------------------|---------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------|--------------|------|------------------|
| V _{DRM} | repetitive peak off-state voltage | BTA316X-600B; BTA316X-600C; BTA316X-600E | <u>[1]</u> _ | 600 | V |
| | BTA316X-800B; BTA316X-800C; BTA316X-800E | - | 800 | V | |
| I _{T(RMS)} | RMS on-state current | full sine wave; T _h ≤ 45 °C; see <u>Figure 4</u> and <u>5</u> | - | 16 | A |
| I _{TSM} non-repetitive peak on-state current | | full sine wave; $T_j = 25 \text{ °C prior to}$ surge; see Figure 2 and 3 | | | |
| | | t = 20 ms | - | 140 | А |
| | | t = 16.7 ms | - | 150 | А |
| l ² t | l ² t for fusing | t = 10 ms | - | 98 | A ² s |
| dl _T /dt | rate of rise of on-state current | $\begin{split} I_{TM} &= 20 \text{ A}; \text{ I}_{G} = 0.2 \text{ A}; \\ dI_{G}/dt &= 0.2 \text{ A}/\mu \text{s} \end{split}$ | - | 100 | A/μs |
| I _{GM} | peak gate current | | - | 2 | А |
| P _{GM} | peak gate power | | - | 5 | W |
| P _{G(AV)} | average gate power | over any 20 ms period | - | 0.5 | W |
| T _{stg} | storage temperature | | -40 | +150 | °C |
| Tj | junction temperature | | - | 125 | °C |

[1] Although not recommended, off-state voltages up to 800 V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 15 A/μs.

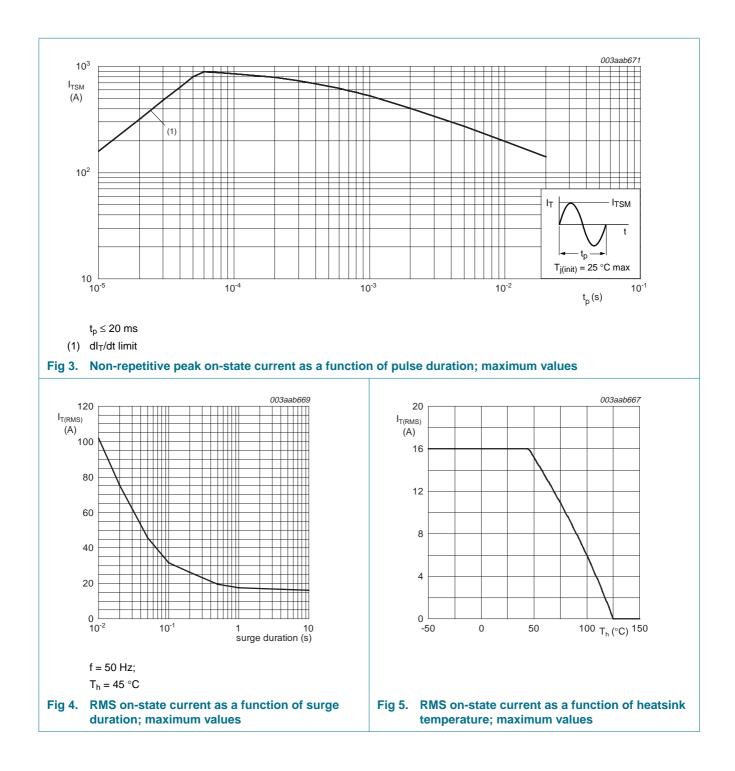
BTA316X series B, C and E

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BTA316X series B, C and E

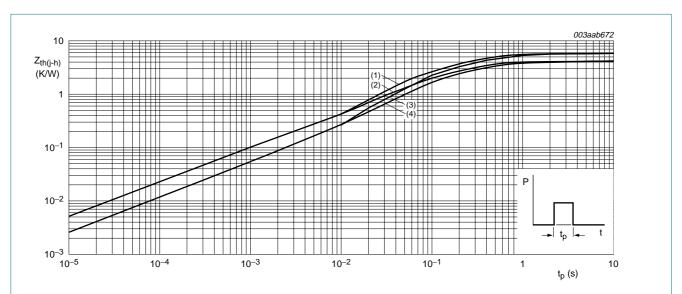
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5. Thermal characteristics

| Table 4. | Thermal characteristics | | | | | |
|----------------------|----------------------------------------------|-------------------------------------------------------------------------|-----|-----|-----|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| R _{th(j-h)} | thermal resistance from junction to heatsink | full or half cycle without heatsink compound; see <u>Figure 6</u> | - | - | 5.5 | K/W |
| | | full or half cycle with heatsink compound; see Figure 6 | - | - | 4.0 | K/W |
| R _{th(j-a)} | thermal resistance from junction to ambient | in free air | - | 55 | - | K/W |



- (1) Unidirectional (half cycle) without heatsink compound
- (2) Unidirectional (half cycle) with heatsink compound
- (3) Bidirectional (full cycle) without heatsink compound
- (4) Bidirectional (full cycle) with heatsink compound
- Fig 6. Transient thermal impedance from junction to heatsink as a function of pulse duration

6. Isolation characteristics

Table 5. Isolation limiting values and characteristics $T = 25 \degree$ C unloss otherwise specified

| $T_h = 25 ^{\circ}C unless$ | s otherwise sp | ecified. |
|------------------------------|----------------|----------|

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-------------------------|-----------------------|--------------------------------------------------------------------------------------------------------------------------------------|-----|-----|------|------|
| V _{isol} (RMS) | RMS isolation voltage | from all three terminals to external heatsink; f = 50 Hz to 60 Hz; sinusoidal waveform; RH \leq 65 %; clean and dust free | - | - | 2500 | V |
| C _{isol} | isolation capacitance | from pin 2 to external heatsink; f = 1 MHz | - | 10 | - | pF |

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7. Static characteristics

Table 6.Static characteristics

 $T_i = 25 \circ C$ unless otherwise specified.

| Symbol | Parameter | Conditions | | A316X- A316X- | | BTA316X-600C BTA316X-800C | | | | BTA316X-600E BTA316X-800E | | |
|---------------------|-------------------------|--------------------------------------------------------------------------|------|------------------|-----|------------------------------|-----|-----|------|------------------------------|-----|----|
| | | | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | _ |
| I _{GT} | gate trigger current | V _D = 12 V; I _T = 0.1 A; see <u>Figure 8</u> | | | | | | | | | | |
| | | T2+ G+ | 2 | - | 50 | 2 | - | 35 | - | - | 10 | mA |
| | | T2+ G– | 2 | - | 50 | 2 | - | 35 | - | - | 10 | mA |
| | | T2– G– | 2 | - | 50 | 2 | - | 35 | - | - | 10 | mA |
| IL latching current | latching current | $V_D = 12 V;$ I _{GT} = 0.1 A; see <u>Figure 10</u> | | | | | | | | | | |
| | | T2+ G+ | - | - | 60 | - | - | 50 | - | - | 25 | mA |
| | | T2+ G– | - | - | 90 | - | - | 60 | - | - | 30 | mA |
| | | T2– G– | - | - | 60 | - | - | 50 | - | - | 30 | mA |
| I _H | holding current | $V_D = 12 V;$ I _{GT} = 0.1 A; see <u>Figure 11</u> | - | - | 60 | - | - | 35 | - | - | 15 | mA |
| V _T | on-state voltage | I _T = 18 A; see <u>Figure 9</u> | - | 1.3 | 1.5 | - | 1.3 | 1.5 | - | 1.3 | 1.5 | V |
| | gate trigger voltage | $V_D = 12 V;$ $I_T = 0.1 A;$ see <u>Figure 7</u> | - | 0.8 | 1.5 | - | 0.8 | 1.5 | - | 0.8 | 1.5 | V |
| | | $V_D = 400 V;$ $I_T = 0.1 A;$ $T_j = 125 \ ^{\circ}C$ | 0.25 | 0.4 | - | 0.25 | 0.4 | - | 0.25 | 0.4 | - | V |
| I _D | off-state current | $V_D = V_{DRM(max)};$ $T_j = 125 \ ^{\circ}C$ | - | 0.1 | 0.5 | - | 0.1 | 0.5 | - | 0.1 | 0.5 | mA |

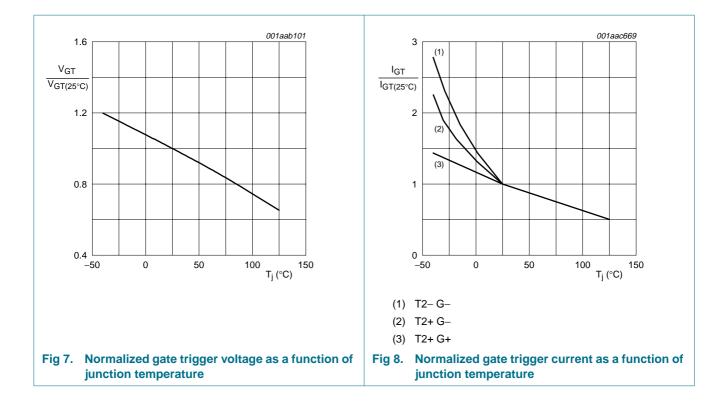
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8. Dynamic characteristics

| Symbol | Parameter | Conditions | | BTA316X-600B BTA316X-800B | | BTA316X-600C BTA316X-800C | | BTA316X-600E BTA316X-800E | | | Unit | |
|---------------------|-----------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|------------------------------|-----|------------------------------|-----|------------------------------|-----|-----|------|------|
| | | | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | |
| dV _D /dt | rate of rise of off-state voltage | $\begin{split} V_{DM} &= 0.67 \times \\ V_{DRM(max)}; \\ T_j &= 125 \ ^\circ\text{C}; \\ exponential \\ waveform; gate open \\ circuit \end{split}$ | 1000 | - | - | 500 | - | - | 60 | - | - | V/µs |
| of | commutating | $\label{eq:VDM} \begin{split} V_{DM} &= 400 \text{ V};\\ T_j &= 125 \ ^\circ\text{C};\\ I_{T(RMS)} &= 16 \text{ A};\\ \text{without snubber};\\ \text{gate open circuit} \end{split}$ | 20 | - | - | 15 | - | - | 5 | - | - | A/ms |
| | | $V_{DM} = 400 \text{ V};$ $T_j = 125 \text{ °C};$ $I_{T(RMS)} = 16 \text{ A};$ $dV/dt = 10 \text{ V}/\mu \text{s};$ gate open circuit | - | - | - | - | - | - | 8 | - | - | A/ms |
| | | $\begin{split} V_{DM} &= 400 \text{ V}; \\ T_{j} &= 125 \text{ °C}; \\ I_{T(RMS)} &= 16 \text{ A}; \\ dV/dt &= 1 \text{ V}/\mu \text{s}; \text{ gate} \\ \text{open circuit} \end{split}$ | - | - | - | - | - | - | 12 | - | - | A/ms |
| t _{gt} | gate-controlled turn-on time | $\begin{split} I_{TM} &= 20 \text{ A};\\ V_D &= V_{DRM(max)};\\ I_G &= 0.1 \text{ A};\\ dI_G/dt &= 5 \text{ A}/\mu\text{s} \end{split}$ | - | 2 | - | - | 2 | - | - | 2 | - | μs |

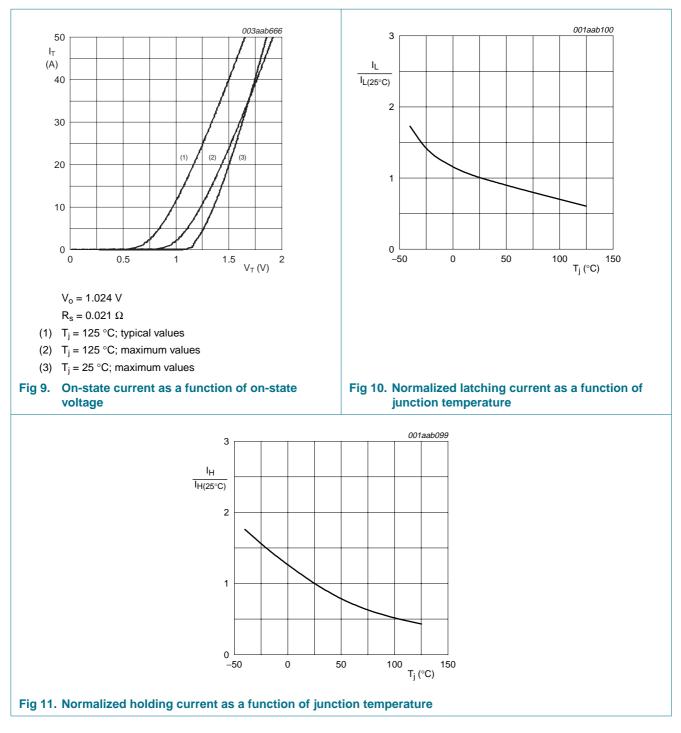
BTA316X series B, C and E

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BTA316X series B, C and E

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9. Package information

Epoxy meets UL94 V-0 at 3.175 mm

BTA316X_SER_B_C_E_1

BTA316X series B, C and E

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10. Package outline

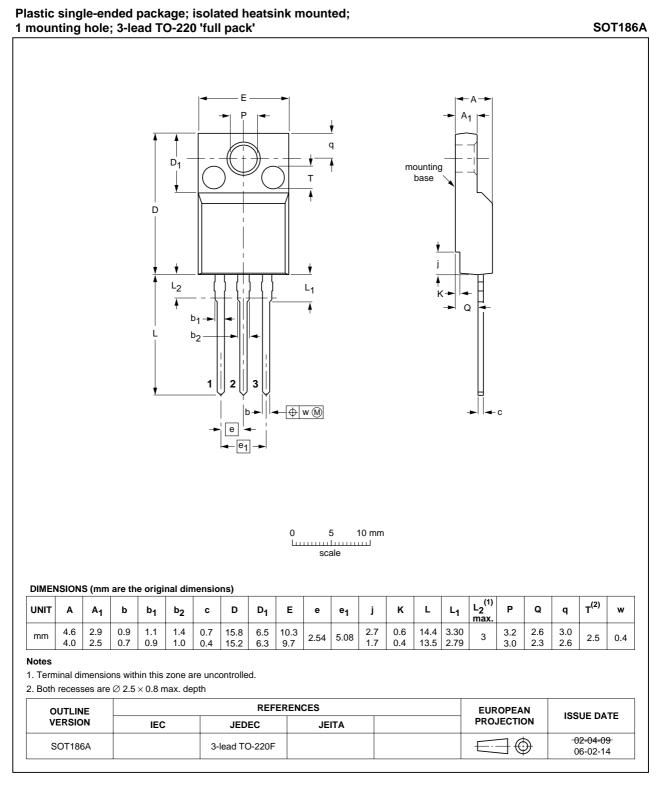


Fig 12. Package outline SOT186A (TO-220F)

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11. Revision history

| Table 8. Revision histor | у | | | |
|--------------------------|--------------|--------------------|---------------|------------|
| Document ID | Release date | Data sheet status | Change notice | Supersedes |
| BTA316X_SER_B_C_E_1 | 20070411 | Product data sheet | - | - |

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12. Legal information

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| Document status ^{[1][2]} | Product status ^[3] | Definition |
|-----------------------------------|-------------------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
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